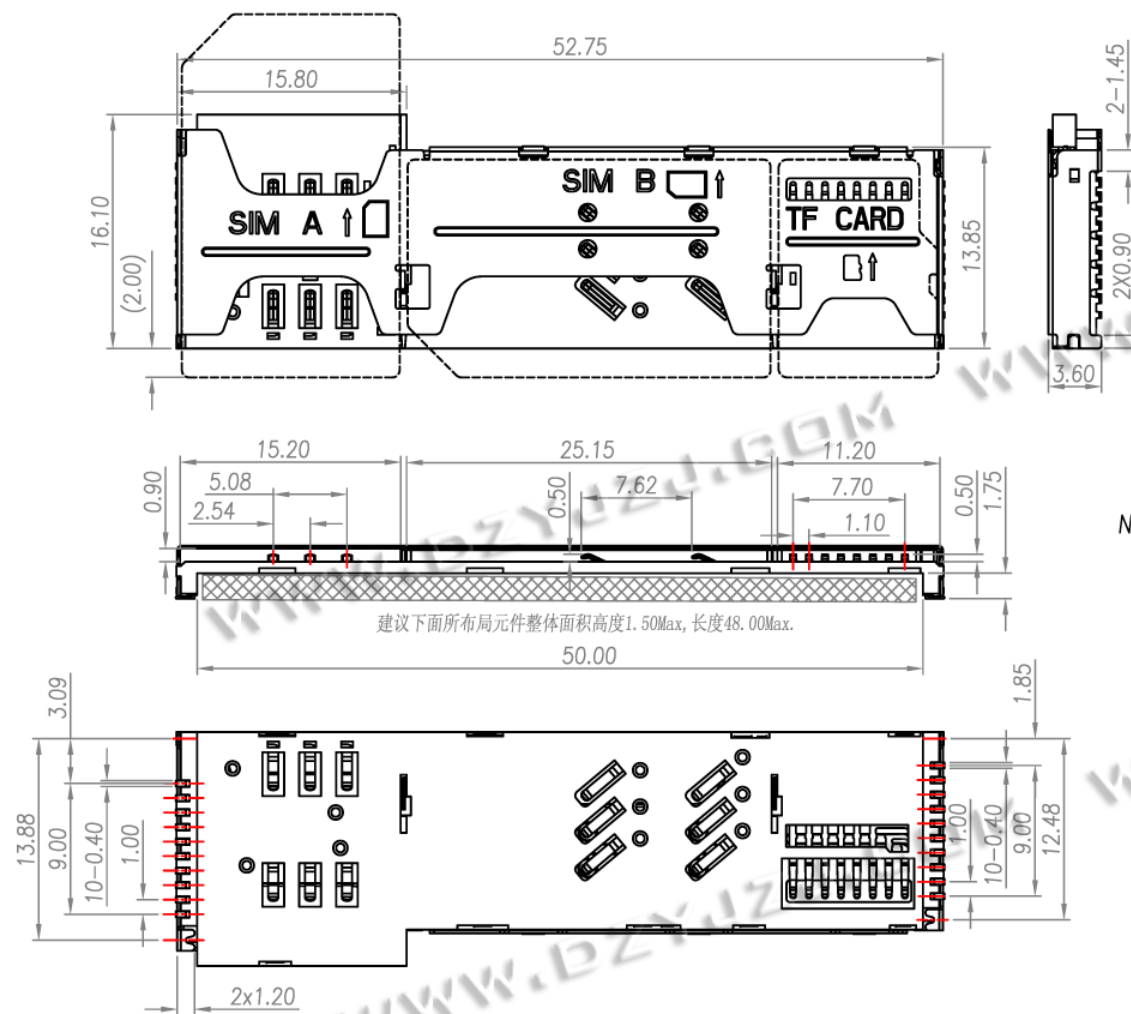




NOTES:

1) MATERIAL:

1-1 HOUSING: THERMOPLASTIC, UL 94V-0, COLOR: BLACK

1-2 CONTACT: COPPER ALLOY, T=0.15mm

1-3 SHELL: STAINLESS STEEL T=0.20mm

2) FINISH:

2-1 CONTACT: GOLD PLATING ON CONTACT AREA (SEE P/N DESCRIPTION)

1u" MIN Au PLATING ON SOLDER AREA,

50u" MIN NICKEL UNDERPLATING OVER ALL

2-2 SHELL: 1u" MIN Au PLATING ON SOLDER AREA

50u" MIN NICKEL UNDERPLATING OVER ALL

3) PRODUCT SPECIFICATIONS:

3-1 VOLTAGE RATING: 50V

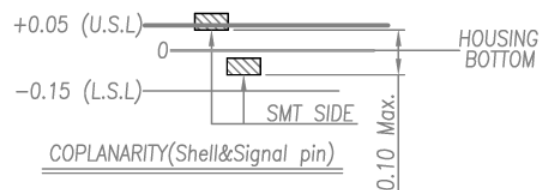
3-2 CURRENT RATING: 1.0A

3-3 INSULATION RESISTANCE: 1000MEG.OHM MIN

3-4 CONTACT RESISTANCE: 50 MILL.OHM MAX

3-5 OPERATION TEMPERATURE: -20° TO +85°

3-6 DURABILITY: 3000 CYCLES



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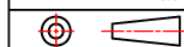
TOLERANCE:

X.X ±0.30

X.XX ±0.25

X.XXX ±0.15

X' ±2" X.X' ±0.5"



UNIT: mm [inch]

SCALE: 1:1 SIZE: A4

DRAWN BY:

陈一鸣

DATE:

2014-02-23

PART NAME:

并排三合一卡座 (横竖SIM+TF) 3.6H

CHECKED BY:

马跃

DATE:

2014-02-23

PART NO.

HYC16-3IN120-527

APPROVED BY:

邱国夷

DATE:

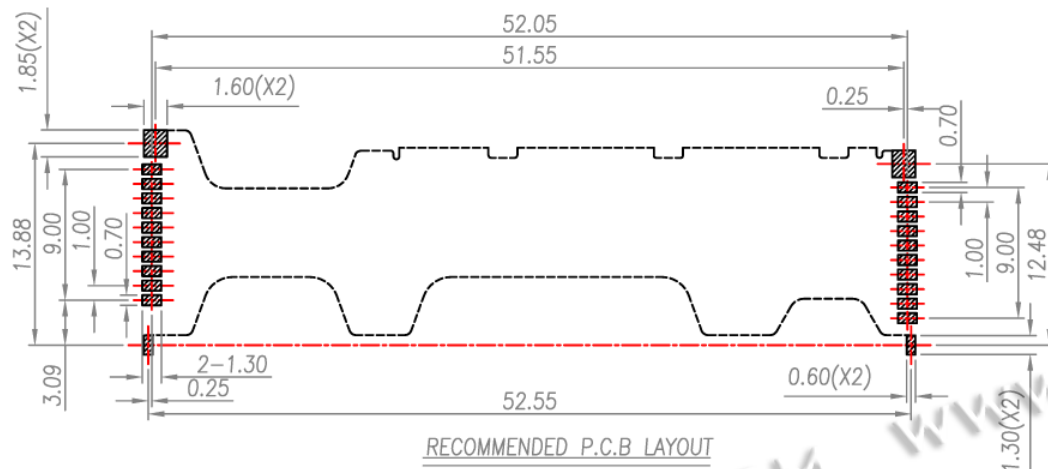
2014-02-23

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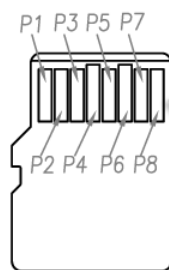
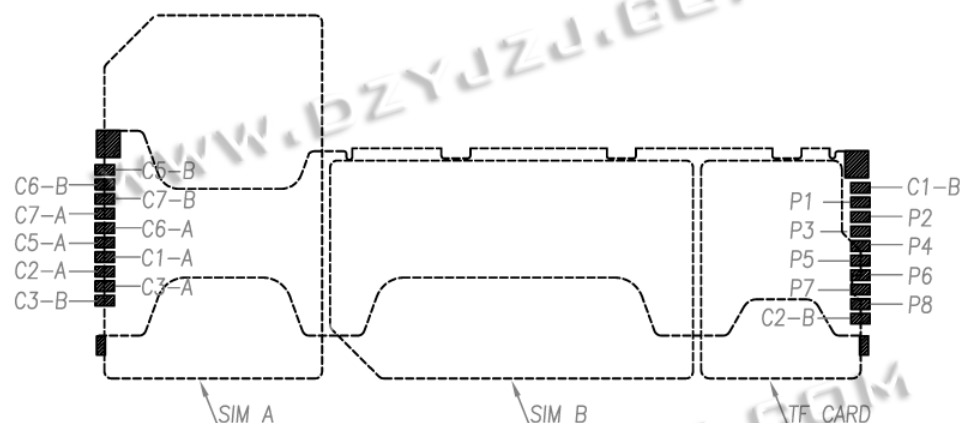
HYC-IN13586321

SHEET NO.

1 OF 2



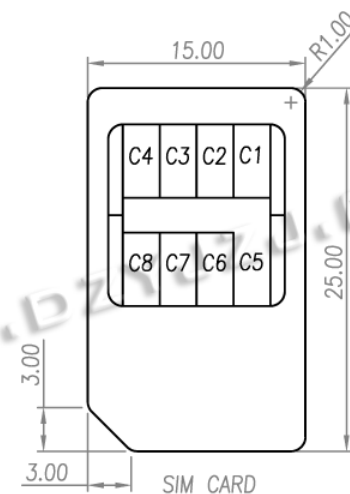
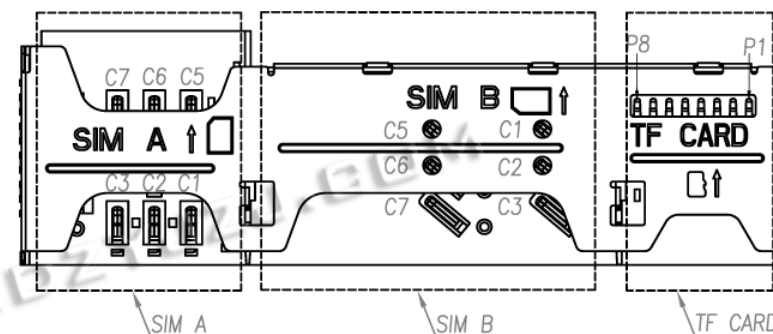
RECOMMENDED P.C.B LAYOUT
GENERAL TOLERANCES:±0.05



Micro-SD CARD

Pin No.	NAME	TYPE	DESCRIPTION
1	DAT 2	I/O/PP	Date Line(bit2)
2	CD/DAT 3	I/O/PP	Card Detect/Date Line(bit3)
3	CMD	PP	Command Response
4	VDD	S	Supply Voltage
5	CLK	I	Colck
6	VSS	S	Supply Voltage Ground
7	DAT0	I/O/PP	Date Line(bit0)
8	DAT1	I/O/PP	Date Line(bit1)

DETECT PIN



C1:VCC
C2:RST
C3:CLK
C4:RESERVED
C5:GND
C6:VPP
C7:I/O
C8:RESERVED



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TOLERANCE: X.X ±0.30 X.XX ±0.25 X.XXX ±0.15 X.° ±2° X.X' ±0.5'		DRAWN BY : 陈一鸣	DATE : 2014-02-23	PART NAME: 并排三合一卡座（横竖SIM+TF）3.6H	
 UNIT: mm [inch]		CHECKED BY: 马跃	DATE : 2014-02-23	PART NO.	HYC16-3IN120-527
		APPROVED BY: 邱国夷	DATE : 2014-02-23	MOLD NO.	
				DRAW NO:	HYC-IN113586321
				SHEET NO.	2 OF 2
SCALE:1:1	SIZE: A4				